imall

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D Series Power MOSFET

PRODUCT SUMMARY				
V_{DS} (V) at T_J max.	550			
R _{DS(on)} max. at 25 °C (Ω)	$V_{GS} = 10 V$	0.4		
Q _g (Max.) (nC)	58			
Q _{gs} (nC)	8			
Q _{gd} (nC)	14			
Configuration	Single			

TO-247AC





N-Channel MOSFET

FEATURES

- Optimal Design
 - Low Area Specific On-Resistance
 - Low Input Capacitance (Ciss)
 - Reduced Capacitive Switching Losses
 - High Body Diode Ruggedness
 - Avalanche Energy Rated (UIS)
- Optimal Efficiency and Operation
 - Low Cost
 - Simple Gate Drive Circuitry
 - Low Figure-of-Merit (FOM): Ron x Qa
 - Fast Switching
- Material categorization: For definitions of compliance please see <u>www.vishay.com/doc?99912</u>

Note

Lead (Pb)-containing terminations are not RoHS-compliant. Exemptions may apply.

APPLICATIONS

- Consumer Electronics
- Displays (LCD or Plasma TV)
- Server and Telecom Power Supplies

 SMPS
- Industrial
 - Welding, Induction Heating, Motor Drives
- Battery Chargers

ORDERING INFORMATION	
Package	TO-247AC
Lead (Pb)-free	SiHG14N50D-E3
Lead (Pb)-free and Halogen-free	SiHG14N50D-GE3

ABSOLUTE MAXIMUM RATINGS (T _C = 25 °C, unless otherwise noted)						
PARAMETER		SYMBOL	LIMIT	UNIT		
Drain-Source Voltage			V _{DS}	500		
Gate-Source Voltage			V _{GS}	± 30	V	
Gate-Source Voltage AC (f > 1 Hz)				30]	
Continuous Drain Current (T _J = 150 °C)	Vec at 10 V	T _C = 25 °C	1	14	А	
	VGS AL TU V	T _C = 100 °C	۱D	9		
Pulsed Drain Current ^a			I _{DM}	38		
Linear Derating Factor				1.6	W/°C	
Single Pulse Avalanche Energy ^b			E _{AS}	56	mJ	
Maximum Power Dissipation			PD	208	W	
Operating Junction and Storage Temperature Range		T _J , T _{stg}	- 55 to + 150	°C		
Drain-Source Voltage Slope	T _J = 125 °C		d\//dt	24	V/nc	
Reverse Diode dV/dt ^d		av/ut	0.4	V/115		
Soldering Recommendations (Peak Temperature) for 10 s			300 ^c	°C		

Notes

a. Repetitive rating; pulse width limited by maximum junction temperature.

b. V_{DD} = 50 V, starting T_J = 25 °C, L = 2.3 mH, R_g = 25 Ω , I_{AS} = 7 A.

c. 1.6 mm from case. d. $I_{SD} \leq I_D,$ starting T_J = 25 °C.

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HALOGEN

FREE

Available



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THERMAL RESISTANCE RATINGS						
PARAMETER	SYMBOL	TYP.	MAX.	UNIT		
Maximum Junction-to-Ambient	R _{thJA}	-	62	°C/W		
Maximum Junction-to-Case (Drain)	R _{thJC}	-	0.6			

SPECIFICATIONS (T _J = 25 °C, unless otherwise noted)								
PARAMETER	SYMBOL	TES	MIN.	TYP.	MAX.	UNIT		
Static		•						
Drain-Source Breakdown Voltage	V _{DS}	V _{GS}	= 0 V, I _D = 250 μA	500	-	-	V	
V _{DS} Temperature Coefficient	$\Delta V_{DS}/T_{J}$	Reference	e to 25 °C, I _D = 250 μA	-	0.58	-	V/°C	
Gate-Source Threshold Voltage (N)	V _{GS(th)}	V _{DS} =	= V _{GS} , I _D = 250 μΑ	3.0	-	5.0	V	
Gate-Source Leakage	I _{GSS}		$V_{GS} = \pm 30 V$	-	-	± 100	nA	
Zoro Gato Voltago Drain Current	la a a	V _{DS} =	V _{DS} = 500 V, V _{GS} = 0 V V _{DS} = 400 V, V _{GS} = 0 V, T _J = 125 °C		-	1		
Zero Gale voltage Drain Gurrent	DSS	V _{DS} = 400 V			-	10	μΑ	
Drain-Source On-State Resistance	R _{DS(on)}	$V_{GS} = 10 V$	I _D = 7 A	-	0.320	0.40	Ω	
Forward Transconductance ^a	g _{fs}	V _{DS}	_s = 50 V, I _D = 7 A	-	5.2	-	S	
Dynamic						-		
Input Capacitance	C _{iss}		V _{GS} = 0 V,		1144	-		
Output Capacitance	C _{oss}		V _{DS} = 100 V,	-	100	-		
Reverse Transfer Capacitance	C _{rss}		f = 1 MHz		12	-		
Effective Output Capacitance, Energy related ^a	C _{o(er)}	V_{GS} = 0 V, V_{DS} = 0 V to 400 V		-	87	-	pF	
Effective Output Capacitance, Time related ^b	C _{o(tr)}			-	125	-		
Total Gate Charge	Qg			-	29	58		
Gate-Source Charge	Q _{gs}	$V_{GS} = 10 V$	$I_D = 7 \text{ A}, V_{DS} = 400 \text{ V}$	-	8	-	nC	
Gate-Drain Charge	Q _{gd}				14	-		
Turn-On Delay Time	t _{d(on)}		·		16	32		
Rise Time	t _r	V_{DD} = 400 V, I _D = 7 A R _g = 9.1 Ω , V _{GS} = 10 V		-	27	54	ns	
Turn-Off Delay Time	t _{d(off)}			-	29	58		
Fall Time	t _f			-	26	52		
Gate Input Resistance	R _g	f = 1 MHz, open drain		-	1.7	-	Ω	
Drain-Source Body Diode Characteristic	cs							
Continuous Source-Drain Diode Current	١ _S	MOSFET sym showing the	MOSFET symbol showing the		-	14	•	
Pulsed Diode Forward Current	I _{SM}	integral reverse		-	-	56	A	
Diode Forward Voltage	V _{SD}	$T_{J} = 25 \text{ °C}, I_{S} = 7 \text{ A}, V_{GS} = 0 \text{ V}$		-	-	1.2	V	
Reverse Recovery Time	t _{rr}	$T_J = 25 \text{ °C}, I_F = I_S = 7 \text{ A},$ dl/dt = 100 A/µs, V _R = 20 V		-	319	-	ns	
Reverse Recovery Charge	Q _{rr}			-	3.0	-	μC	
Reverse Recovery Current	I _{RRM}			-	18	-	A	

Note

a. $C_{oss(er)}$ is a fixed capacitance that gives the same energy as C_{oss} while V_{DS} is rising from 0 % to 80 % V_{DSS} . b. $C_{oss(tr)}$ is a fixed capacitance that gives the same charging time as C_{oss} while V_{DS} is rising from 0 % to 80 % V_{DSS} .



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TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)





Fig. 2 - Typical Output Characteristics



Fig. 3 - Typical Transfer Characteristics



Fig. 4 - Normalized On-Resistance vs. Temperature



Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage





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Fig. 9 - Maximum Drain Current vs. Case Temperature



Fig. 10 - Typical Drain-to-Source Voltage vs. Temperature





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Fig. 12 - Switching Time Test Circuit



Fig. 13 - Switching Time Waveforms



Fig. 14 - Unclamped Inductive Test Circuit



Fig. 15 - Unclamped Inductive Waveforms



Fig. 16 - Basic Gate Charge Waveform



Fig. 17 - Gate Charge Test Circuit

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Peak Diode Recovery dV/dt Test Circuit



a. $V_{GS} = 5$ V for logic level devices

Fig. 18 - For N-Channel

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TO-247AC (High Voltage)

ECN: X13-0103-Rev. D, 01-Jul-13 DWG: 5971

Notes

1. Dimensioning and tolerancing per ASME Y14.5M-1994.

2. Contour of slot optional.

 Dimension D and E do not include mold flash. Mold flash shall not exceed 0.127 mm (0.005") per side. These dimensions are measured at the outermost extremes of the plastic body.

4. Thermal pad contour optional with dimensions D1 and E1.

5. Lead finish uncontrolled in L1.

6. Ø P to have a maximum draft angle of 1.5 to the top of the part with a maximum hole diameter of 3.91 mm (0.154").

7. Outline conforms to JEDEC outline TO-247 with exception of dimension c.

8. Xian and Mingxin actually photo.



Document Number: 91360



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